



Emerging Technologies for 6G Intelligent Wireless Communications

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Message from the Guest Editors

Recently, the breakthrough in novel algorithms, fundamental theories, and hardware technologies have enabled the emerging intelligent wireless communications, achieving high energy efficiency and intelligent applications. Prospective authors are invited to submit original manuscripts on topics that include, but are not limited to, the following:

- Signal processing algorithms for the design of intelligent wireless communications;
- AI-driven algorithm for intelligent wireless communications;
- Modelling and estimation of channel measurements for intelligent wireless communications;
- Experimental/theoretical evaluation of transceivers for intelligent wireless communications;
- Optimization of intelligent wireless communications;
- Intelligent wireless communications for integrated communications and sensing;
- Cooperative signal processing for intelligent wireless communications;
- Resource allocation, medium access control, and scheduling for intelligent wireless communications;
- Compatibility of intelligent wireless communications with other key 5G/6G technologies.





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Message from the Editor-in-Chief

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